



NOMINAL SIZE =

1.37 in x 1.12 in (34,8 mm x 28,5 mm)

#### **Features**

- Up to 30 A Output Current
- 5-V Input Voltage
- Wide-Output Voltage Adjust (0.8 V to 3.6 V)
- 180 W/in³ Power Density
- On/Off Inhibit
- Efficiencies up to 94 %
- Pre-Bias Startup
- Margin Up/Down Controls
- Under-Voltage Lockout

- Auto-Track<sup>TM</sup> Sequencing
- Output Over-Current Protection (Non-Latching, Auto-Reset)
- Over-Temperature Protection
- Operating Temp: -40 to +85 °C
- Safety Agency Approvals: UL 1950, CSA 22.2 950, EN60950 VDE (Pending)
- Point-of-Load Alliance (POLA) Compatible

#### **Description**

The PTH05030 is a series of high-current non-isolated power modules from Texas Instruments. This product is characterized by high efficiencies, and up to 30 A of output current, while occupying a mere 1.64 in² of PCB area. In terms of cost, size, and performance, the series provides OEM's with a flexible module that meets the requirements of the most complex and demanding mixed-signal applications. These include the most densly populated, multi-processor systems that incorporate high-speed DSP's, microprocessors, and ASICs.

The series uses double-sided surface mount construction and provides highperformance step-down power conversion from a 5-V input bus voltage. The output voltage of the PTH05030W can be set to any value over the range 0.8 V to 3.6 V, using a single resistor.

This series includes Auto-Track<sup>™</sup>. Auto-Track simplifies power-up and power-down supply voltage sequencing in a system by enabling modules to track each other, or any other external voltage.

Each model also includes an on/off inhibit, output voltage adjust (trim), and margin up/down controls. An output voltage sense ensures tight load regulation, and an output over-current and thermal shutdown feature provide for protection against external load faults.

Package options inlude both throughhole and surface mount configurations.

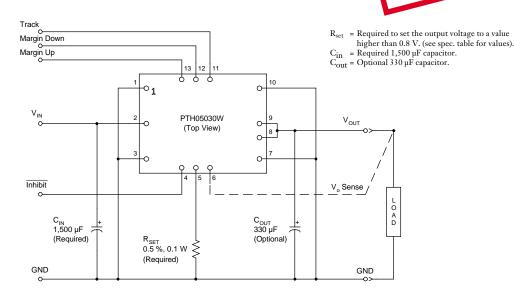
#### **Pin Configuration**

Pin	Function
1	GND
2	V <sub>in</sub>
3	GND
4	Inhibit *
5	V <sub>o</sub> Adjust
6	Vo Sense
7	GND
8	V <sub>out</sub>
9	V <sub>out</sub>
10	GND
11	Track
12	Margin Down *
13	Margin Up *

Denotes negative logic:
Open = Normal operation
Ground = Function active

<u>S</u>equencing

#### **Standard Application**





#### 30-A, 5-V Input Non-Isolated **Wide-Output Adjust Power Modules**

#### **Ordering Information**

Output \	/oltage (PTH05030□xx)	Package Options (PTH05030x 1) (1)				
Code	Voltage	Code	Description	Pkg Ref. (2)		
$\mathbf{W}$	0.8 V – 3.6 V (Adjust)	AH	Horiz. T/H	(EUM)		
		AS	SMD, Standard (3)	(EUN)		

- Notes: (1) Add "T" to end of part number for tape and reel on SMD packages only.
  (2) Reference the applicable package reference drawing for the dimensions and PC board layout
  (3) "Standard" option specifies 63/37, Sn/Pb pin solder material.

#### **Pin Descriptions**

Vin: The positive input voltage power node to the module, which is referenced to common *GND*.

**Vout:** The regulated positive power output with respect to the GND node.

**GND:** This is the common ground connection for the Vin and Vout power connections. It is also the 0 VDC reference for the control inputs.

Inhibit: The Inhibit pin is an open-collector/drain negative logic input that is referenced to GND. Applying a lowlevel ground signal to this input disables the module's output and turns off the output voltage. When the Inhibit control is active, the input current drawn by the regulator is significantly reduced. If the *Inhibit* pin is left open-circuit, the module will produce an output whenever a valid input source is applied.

**Vo Adjust:** A 0.1 W 1 % resistor must be directly connected between this pin and pin 7 (GND) to set the output voltage to a value higher than 0.8 V. The temperature stability of the resistor should be 100 ppm/°C (or better). The set point range for the output voltage is from 0.8 V to 3.6 V. The resistor value required for a given output voltage may be calculated from the following formula. If left open circuit, the output voltage will default to its lowest value. For further information on output voltage adjustment consult the related application note.

$$R_{\text{set}}$$
 = 10 k  $\cdot \frac{0.8 \text{ V}}{V_{\text{out}} - 0.8 \text{ V}}$  - 2.49 k

The specification table gives the preferred resistor values for a number of standard output voltages.

Vo Sense: The sense input allows the regulation circuit to compensate for voltage drop between the module and the load. For optimal voltage accuracy Vo Sense should be connected to Vout. It can also be left disconnected.

Track: This is an analog control input that enables the output voltage to follow an external voltage. This pin becomes active typically 20 ms after the input voltage has been applied, and allows direct control of the output voltage from 0 V up to the nominal set-point voltage. Within this range the output will follow the voltage at the Track pin on a volt-for-volt basis. When the control voltage is raised above this range, the module regulates at its set-point voltage. The feature allows the output voltage to rise simultaneously with other modules powered from the same input bus. If unused, this input should be connected to V<sub>in</sub>. Note: Due to the under-voltage lockout feature, the output of the module cannot follow its own input voltage during power up. For more information, consult the related application note.

Margin Down: When this input is asserted to GND, the output voltage is decreased by 5% from the nominal. The input requires an open-collector (open-drain) interface. It is not TTL compatible. A lower percent change can be accomodated with a series resistor. For further information, consult the related application note.

**Margin Up:** When this input is asserted to *GND*, the output voltage is increased by 5%. The input requires an open-collector (open-drain) interface. It is not TTL compatible. The percent change can be reduced with a series resistor. For further information, consult the related application note.

#### 30-A, 5-V Input Non-Isolated **Wide-Output Adjust Power Modules**

#### **Environmental & Absolute Maximum Ratings** (Voltages are with respect to GND)

Characteristics	Symbols	Conditions	Min	Тур	Max	Units
Track Input Voltage	$V_{track}$		-0.3	_	$V_{in} + 0.3$	V
Operating Temperature Range	$T_a$	Over V <sub>in</sub> Range	-40		85	°C
Solder Reflow Temperature	$T_{reflow}$	Surface temperature of module body or pins			235 (i)	°C
Storage Temperature	$T_s$	_	-40	_	125	°C
Mechanical Shock		Per Mil-STD-883D, Method 2002.3 1 msec, ½ Sine, mounted	_	500	_	G's
Mechanical Vibration		Mil-STD-883D, Method 2007.2 Suffix S 20-2000 Hz Suffix H	_	10 20	_	G's
Weight	_		_	10	_	grams
Flammability	_	Meets UL 94V-O				

Notes: (i) During reflow of SMD package version do not elevate peak temperature of the module, pins or internal components above the stated maximum.

#### **Specifications** (Unless otherwise stated, $T_a = 25$ °C, $V_{in} = 5$ V, $V_{out} = 3.3$ V, $C_{in} = 1,500$ $\mu$ F, $C_{out} = 0$ $\mu$ F, and $I_o = I_o max$ )

	_					
Characteristics	Symbols	Conditions	Min	Тур	Max	Units
Output Current	$I_{o}$	60 °C, 200 LFM airflow 25 °C, natural convection	0	_	30 (1) 30 (1)	A
Input Voltage Range	$V_{in}$	Over I <sub>o</sub> range	4.5	_	5.5	V
Set-Point Voltage Tolerance	$V_{o}$ tol		_	_	±2 (2)	$%V_{o}$
Temperature Variation	$\Delta \text{Reg}_{\text{temp}}$	$-40 ^{\circ}\text{C} < T_a < +85 ^{\circ}\text{C}$	_	±0.5	_	$%V_{o}$
Line Regulation	$\Delta \text{Reg}_{\text{line}}$	Over V <sub>in</sub> range	_	±10	_	mV
Load Regulation	$\Delta Reg_{load}$	Over Io range	_	±12	_	mV
Total Output Variation	$\Delta Reg_{tot}$	Includes set-point, line, load, -40 °C $\leq$ T <sub>a</sub> $\leq$ +85 °C	_	_	±3	$%V_{o}$
Efficiency	η	$\begin{array}{c} \rm I_{o}\text{=}20A & R_{SET}\text{=}698\Omega  V_{o}\text{=}3.3V \\ R_{SET}\text{=}2.21k\Omega  V_{o}\text{=}2.5V \\ R_{SET}\text{=}8.78k\Omega  V_{o}\text{=}1.8V \\ R_{SET}\text{=}8.78k\Omega  V_{o}\text{=}1.5V \\ R_{SET}\text{=}1.74k\Omega  V_{o}\text{=}1.2V \\ R_{SET}\text{=}3.65k\Omega  V_{o}\text{=}1.0V \end{array}$		94 93 90 89 87 86		%
V <sub>o</sub> Ripple (pk-pk)	V <sub>r</sub>	20 MHz bandwidth	_	40	_	mVpp
Over-Current Threshold	I <sub>o</sub> trip	Reset, followed by auto-recovery	_	47	_	A
Transient Response	$ au_{ m tr} \ \Delta V_{ m tr}$	1 A/ $\mu$ s load step, 50 to 100 % $I_{o}$ max, $C_{out}$ = 330 $\mu$ F Recovery Time $V_{o}$ over/undershoot	_	70 100	_	μSec mV
Margin Up/Down Adjust	V <sub>o</sub> adj	V <sub>0</sub> over/ undershoot	_	± 5	_	%
Margin Input Current (pins 12 /13)	I <sub>II.</sub> margin	Pin to GND	_	-8 (3)	_	μA
Track Input Current (pin 11)	Iπ track	Pin to GND	_		-130 (4)	μA
Track Slew Rate Capability	dV <sub>track</sub> /dt	$C_{out} \le C_{out}(max)$	_	_	1	V/ms
Under-Voltage Lockout	UVLO	V <sub>in</sub> increasing V <sub>in</sub> decreasing	3.4	4.3 3.7	4.45	V
Inhibit Control (pin4) Input High Voltage Input Low Voltage	$egin{array}{c} V_{ m IH} \ V_{ m IL} \end{array}$	Referenced to GND	V <sub>in</sub> -0.5 -0.2	_	Open (4) 0.8	V
Input Low Current	$ m I_{IL}$ inhibit	Pin to GND	_	-130	_	μA
Input Standby Current	I <sub>in</sub> inh	Inhibit (pin 4) to GND, Track (pin 11) open	_	10	_	mA
Switching Frequency	$f_{ m s}$	Over V <sub>in</sub> and I <sub>o</sub> ranges	275	300	235	kHz
External Input Capacitance	C <sub>in</sub>		1,500 (5)		_	μF
External Output Capacitance	$C_{out}$	Capacitance value non-ceramic ceramic	0 0	330 (6)	16,500 <sup>(7)</sup> 300	μF
		Equiv. series resistance (non-ceramic)	4 (8)	_	_	$m\Omega$
Reliability	MTBF	Per Bellcore TR-332 50 % stress, T <sub>a</sub> =40 °C, ground benign	2.8	_	_	106 Hrs

Notes: (1) See SOA curves or consult factory for appropriate derating.

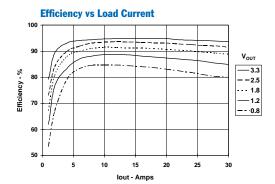
- (2) The set-point voltage tolerlance is affected by the tolerance and stability of RSET. The stated limit is unconditionally met if RSET has a tolerance of 1 % with 100 ppm/°C or better temperature stability.
- (3) A small low-leakage (<100 nA) MOSFET is recommended to control this pin. The open-circuit voltage is less than 1 Vdc.
- (4) This control pin has an internal pull-up to the input voltage Vin. If it is left open-circuit the module will operate when input power is applied. A small low-leakage (<100 nA) MOSFET is recommended for control. For further information, consult the related application note.
- (5) A 1,500 µF electrolytic input capacitor is required for proper operation. The capacitor must be rated for a minimum of 900 mA rms of ripple current.
   (6) An external output capacitor is not required for basic operation. Adding 330 µF of distributed capacitance at the load will improve the transient response.
- This is the calculated maximum. The minimum ESR limitation will often result in a lower value. Consult the application notes for further guidance.
- (8) This is the typical ESR for all the electrolytic (non-ceramic) output capacitance. Use 7 mΩ as the minimum when using max-EŠR values to calculate.



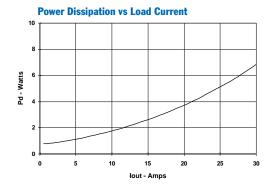
30-A, 5-V Input Non-Isolated Wide-Output Adjust Power Modules

SLTS210B - MAY 2003 - REVISED JANUARY 2004

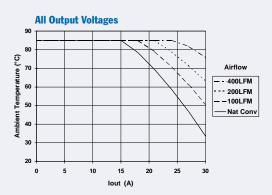
#### **Characteristic Data; V**<sub>in</sub> =5 V (See Note A)



# Output Ripple vs Load Current 100 80 80 Vout --2.5 ... 1.8 -3.3 -1.2 ... 0.8



#### **Safe Operating Area; Vin =5 V** (See Note B)



Note A: Characteristic data has been developed from actual products tested at 25°C. This data is considered typical data for the Converter.

Note B: SOA curves represent the conditions at which internal components are at or below the manufacturer's maximum operating temperatures. Derating limits apply to modules soldered directly to a 4 in. × 4 in. double-sided PCB with 1 oz. copper.



#### PTH03030W & PTH05030W

## Capacitor Recommendations for the PTH03030 & PTH05030 Series of Power Modules

#### **Input Capacitor**

The recommended input capacitor(s) is determined by the 1,500  $\mu$ F <sup>(1)</sup> minimum capacitance and 900 mArms minimum ripple current rating.

Ripple current and <100 m $\Omega$  equivalent series resistance (ESR) values are the major considerations, along with temperature, when designing with different types of capacitors. Unlike polymer tantalum, conventional tantalum capacitors have a recommended minimum voltage rating of 2 × (maximum DC voltage + AC ripple). This is standard practice to ensure reliability.

For improved ripple reduction on the input bus, ceramic capacitors may be used to complement electrolytic types and achieve the minimum required capacitance.

#### **Output Capacitors (Optional)**

For applications with load transients (sudden changes in load current), regulator response will benefit from an external output capacitance. The recommended output capacitance of 330 µF will allow the module to meet its transient response specification (see product data sheet). For most applications, a high quality computer-grade aluminum electrolytic capacitor is most suitable. These capacitors provide adequate decoupling over the frequency range, 2 kHz to 150 kHz, and are suitable when ambient temperatures are above 0 °C. For operation below 0 °C, tantalum, ceramic or Os-Con type capacitors are recommended. When using one or more non-ceramic capacitors, the calculated equivalent ESR should be no lower than  $4 \text{ m}\Omega$  (7 m $\Omega$  using the manufacturer's maximum ESR for a single capacitor). A list of preferred low-ESR type capacitors are identified in Table 1-1.

#### **Ceramic Capacitors**

Above 150 kHz the performance of aluminum electrolytic capacitors becomes less effective. To further improve the reflected input ripple current or the output transient response, multilayer ceramic capacitors can also be added. Ceramic capacitors have very low ESR and their resonant frequency is higher than the bandwidth of the regulator. When used on the output their combined ESR is not critical as long as the total value of ceramic capacitance does not exceed 300  $\mu F$ . Also, to prevent the formation of local resonances, do not place more than five identical ceramic capacitors in parallel with values of 10  $\mu F$  or greater.

#### **Tantalum Capacitors**

Tantalum type capacitors can be used at both the input and output, and are recommended for applications where the ambient operating temperature can be less than 0 °C. The AVX TPS, Sprague 593D/594/595 and Kemet T495/T510 capacitor series are suggested over many other tantalum types due to their higher rated surge, power

dissipation, and ripple current capability. As a caution many general purpose tantalum capacitors have considerably higher ESR, reduced power dissipation and lower ripple current capability. These capacitors are also less reliable when determining their power dissipation and surge current capability. Tantalum capacitors that do not have a stated ESR or surge current rating are not recommended for power applications.

When specifying Os-Con and polymer tantalum capacitors for the output, the minimum ESR limit will be encountered well before the maximum capacitance value is reached.

#### **Capacitor Table**

Table 1-1 identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The recommended number of capacitors required at both the input and output buses is identified for each capacitor type.

This is not an extensive capacitor list. Capacitors from other vendors are available with comparable specifications. Those listed are for guidance. The RMS ripple current rating and ESR (at 100kHz) are critical parameters necessary to insure both optimum regulator performance and long capacitor life.

#### **Designing for Very Fast Load Transients**

The transient response of the DC/DC converter has been characterized using a load transient with a di/dt of 1 A/µs. The typical voltage deviation for this load transient is given in the data sheet specification table using the optional value of output capacitance. As the di/dt of a transient is increased, the response of a converter's regulation circuit ultimately depends on its output capacitor decoupling network. This is an inherent limitation with any DC/DC converter once the speed of the transient exceeds its bandwidth capability. If the target application specifies a higher di/dt or lower voltage deviation, the requirement can only be met with additional output capacitor decoupling. In these cases special attention must be paid to the type, value and ESR of the capacitors selected.

If the transient performance requirements exceed that specified in the data sheet, or the total amount of load capacitance is above 3,000  $\mu$ F, the selection of output capacitors becomes more important. For further guidance consult the separate application note, "Selecting Capacitors for PTH Products in High-Performance Applications."



#### PTH03030W & PTH05030W

Table 1-1: Input/Output Capacitors

Capacitor Vendor, Type: Series (Style)		(	Capacitor Ch	aracteristics		Qua	ntity	
	Working Voltage	Value (µF)	Max. ESR at 100 kHz	Max. Ripple Current @85 °C (I rms)	Physical Size (mm)	Input Bus	Output Bus	Vendor Part Number
Panasonic: FC (Radial) FK (SMD)	10 V 16 V 16 V 10 V	560 1500 1500 2200	0.090 Ω 0.043 Ω 0.060 Ω 0.060 Ω	>900 mA 1690 mA 1100 mA 1100 mA	10×12.5 16×15 12.5×13.5 12.5×13.5	3 1 1 1	1 1 1	EEUFC1A561 EEUFC1C152S EEVFK1C152Q EEVFK1A222Q
United Chemi-con FX, Oscon (Radial) PXA, (Poly-Aluminum (SMD.) LXZ, Aluminum (Radial)	6.3 V 6.3 V 10 V 10 V	1000 820 680 1000	0.013 Ω 0.010 Ω 0.090 Ω 0.068 Ω	4935 mA 5500 mA >900 mA 1050 mA	10×10.5 10×12.2 10×12.5 10×16	2 2 3 2	≤2 ≤2 1	6FX1000M PXA6.3VC820MJ12TP LXZ10VB681M10X12LL LXZ10VB102M10X16LL
Nichicon, Aluminum: HD (Radial) PM (Radial)	6.3 V 10 V	1000 1500	0.053 Ω 0.050 Ω	1030 mA 1060 mA	10×12.5 16×15	2 1	1 1	UHD0J102MPR UPM1A152MHH6
Sanyo, Os-con: SP (Radial) SVP (SMD)	10 V 6.3 V	470 820	0.015 Ω 0.012 Ω	>4500 mA >5440 mA	10×10.5 10×12.7	3 [1] 2	≤3 ≤2	10SP470M 6SVP820M
Panasonic, Poly-Aluminum: WA (SMD) S/SE (SMD)	6.3 V 6.3 V	560 180	0.020 Ω 0.005 Ω	5100 mA 4000 mA	10×10.2 7.3×4.3×4.2	3 N/R	≤4 ≤1	EEFWA0J561P EEFSE0J181R
AVX, Tantalum: TPS (SMD)	10 V 10 V	470 470	0.045 Ω 0.060 Ω	1723 mA 1826 mA	7.3L ×5.7W×4.1H	3 [1] 3 [1]	≤5 ≤5	TPSE477M010R0045 TPSV477M010R0060
Kemet (SMD): T520, Poly-Tant T530, Poly-Tant/Organic	6.3 V 10 V 6.3 V	470 330 470	0.018 Ω 0.015 Ω 0.012 Ω	>1200 mA >3800 mA 4200 mA	4.3W ×7.3L ×4.0H	3 [1] 5 3 [1]	≤5 ≤3 ≤2	T520X477M006SE018 T530X337M010AS T530X477M006AS
Vishay-Sprague 595D, Tantalum (SMD) 94SA, Os-con (Radial)	10 V 16 V	470 2200	0.100 Ω 0.015 Ω	1440 mA 9740 mA	7.2L×6W ×4.1H 16×25	3 [1] 1	≤5 ≤3	595D477X0010R2T 94SA108X0016HBP
Kemet, Ceramic X5R (SMD)	16 V 6.3 V	10 47	0.002 Ω 0.002 Ω	_	1210 case 3225 mm	1 [2] 1 [2]	≤5 ≤5	C1210C106M4PAC C1210C476K9PAC
Murata, Ceramic X5R (SMD)	6.3 V 6.3 V 16 V 16 V	100 47 22 10	0.002 Ω	_	1210 case 3225 mm	1 [2] 1 [2] 1 [2]	≤3 ≤5 ≤5 ≤5	GRM32ER60J107M GRM32ER60J476M GRM32ER61C226K GRM32DR61C106K
TDK, Ceramic X5R (SMD)	6.3 V 6.3 V 16 V 16 V	100 47 22 10	0.002 Ω	_	1210 case 3225 mm	1 [2] 1 [2] 1 [2]	≤3 ≤5 ≤5 ≤5	C3225X5R0J107MT C3225X5R0J476MT C3225X5R1C226MT C3225X5R1C106MT

<sup>[1]</sup> The total capacitance is slightly lower than 1,500 µF, but is acceptable based on the combined ripple current rating.
[2] A ceramic capacitor may be used to complement electrolytic types at the input to further reduce high-frequency ripple current

#### PTH03030W & PTH05030W

# Adjusting the Output Voltage of the PTH03030W & PTH05030W Wide-Output Adjust Power Modules

The  $V_o$  Adjust control (pin 4) sets the output voltage of the PTH03030W and PTH05030W products to a value higher than 0.8 V. The adjustment range of the PT03030W (3.3-V input) is from 0.8 V to 2.5 V <sup>1</sup>, and the PTH05030W (5-V input) from 0.8 V to 3.6 V. For an output voltage other than 0.8 V a single external resistor,  $R_{\rm set}$ , must be connected directly between the  $V_o$  Adjust and GND pins <sup>2</sup>. Table 2-1 gives the preferred value of the external resistor for a number of standard voltages, along with the actual output voltage that this resistance value provides.

For other output voltages the value of the required resistor can either be calculated using the following formula, or simply selected from the range of values given in Table 2-2. Figure 2-1 shows the placement of the required resistor.

$$R_{set} = 10 \text{ k}\Omega \cdot \frac{0.8 \text{ V}}{V_{out} - 0.8 \text{ V}} - 2.49 \text{ k}\Omega$$

Table 2-1; Preferred Values of R<sub>set</sub> for Standard Output Voltages

V <sub>out</sub> (Standard)	R <sub>set</sub> (Pref'd Value)	V <sub>out</sub> (Actual)
3.3 V 1	698 Ω	3.309V
2.5 V	2.21 kΩ	2.502 V
2 V	4.12 kΩ	$2.010\mathrm{V}$
1.8 V	$5.49 \mathrm{k}\Omega$	1.803 V
1.5 V	$8.87~\mathrm{k}\Omega$	$1.504\mathrm{V}$
1.2 V	$17.4 \mathrm{k}\Omega$	1.202 V
1 V	$36.5 \text{ k}\Omega$	1.005 V
0.8 V	Open	0.8 V

Figure 2-1; V. Adjust Resistor Placement

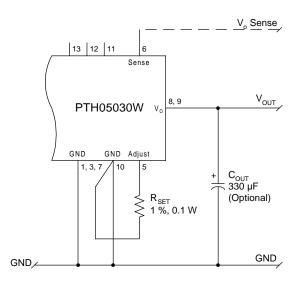


Table 2-2; Output Voltage Set-Point Resistor Values

V <sub>a</sub> Req'd	R <sub>set</sub>	V <sub>a</sub> Req'd	R <sub>set</sub>
0.800	Open	2.00	$4.18~\mathrm{k}\Omega$
0.825	318 kΩ	2.05	3.91 kΩ
0.850	158 kΩ	2.10	3.66 kΩ
0.875	104 kΩ	2.15	$3.44 \mathrm{k}\Omega$
0.900	77.5 kΩ	2.20	3.22 kΩ
0.925	61.5 kΩ	2.25	3.03 kΩ
0.950	50.8 kΩ	2.30	$2.84~\mathrm{k}\Omega$
0.975	43.2 kΩ	2.35	$2.67~\mathrm{k}\Omega$
1.000	37.5 kΩ	2.40	$2.51~\mathrm{k}\Omega$
1.025	33.1 kΩ	2.45	2.36 kΩ
1.050	29.5 kΩ	2.50	$2.22~\mathrm{k}\Omega$
1.075	26.6 kΩ	2.55	$2.08~\mathrm{k}\Omega$
1.100	24.2 kΩ	2.60	1.95 kΩ
1.125	22.1 kΩ	2.65	1.83 kΩ
1.150	20.4 kΩ	2.70	1.72 kΩ
1.175	18.8 kΩ	2.75	1.61 kΩ
1.200	17.5 kΩ	2.80	1.51 kΩ
1.225	16.3 kΩ	2.85	1.41 kΩ
1.250	15.3 kΩ	2.90	1.32 kΩ
1.275	14.4 kΩ	2.95	1.23 kΩ
1.300	13.5 kΩ	3.00	$1.15~\mathrm{k}\Omega$
1.325	12.7 kΩ	3.05	$1.07~\mathrm{k}\Omega$
1.350	12.1 kΩ	3.10	$988\Omega$
1.375	11.4 kΩ	3.15	914Ω
1.400	10.8 kΩ	3.20	843 Ω
1.425	10.3 kΩ	3.25	$775 \Omega$
1.450	9.82 kΩ	3.30	$710\Omega$
1.475	9.36 kΩ	3.35	$647\Omega$
1.50	$8.94~\mathrm{k}\Omega$	3.40	$587\Omega$
1.55	8.18 kΩ	3.45	529 Ω
1.60	7.51 kΩ	3.50	473 Ω
1.65	6.92 kΩ	3.55	419 Ω
1.70	6.4 kΩ	3.60	367 Ω
1.75	5.93 kΩ		
1.80	5.51 kΩ		
1.85	5.13 kΩ		
1.90	4.78 kΩ		

#### Notes:

1.95

1. Modules that operate from a 3.3-V input bus should not be adjusted higher than 2.5 V.

 $4.47~\mathrm{k}\Omega$ 

- Use a 0.1 W resistor. The tolerance should be 1 %, with temperature stability of 100 ppm/°C (or better). Place the resistor as close to the regulator as possible. Connect the resistor directly between pins 5 and 10 using dedicated PCB traces.
- Never connect capacitors from V<sub>o</sub>Adjust to either GND or V<sub>out</sub>. Any capacitance added to the V<sub>o</sub>Adjust pin will affect the stability of the regulator.



# Features of the PTH Family of Non-Isolated Wide Output Adjust Power Modules

#### **Point-of-Load Alliance**

The PTH family of non-isolated, wide-output adjust power modules from Texas Instruments are optimized for applications that require a flexible, high performance module that is small in size. These products are part of the "Point-of-Load Alliance" (POLA), which ensures compatible footprint, interoperability and true second sourcing for customer design flexibility. The POLA is a collaboration between Texas Instruments, Artesyn Technologies, and Astec Power to offer customers advanced non-isolated modules that provide the same functionality and form factor. Product series covered by the alliance includes the PTHxx050W (6 A), PTHxx060W (10 A), PTHxx010W (15/12 A), PTHxx020W (22/18 A), and the PTHxx030W (30/26 A).

From the basic, "Just Plug it In" functionality of the 6-A modules, to the 30-A rated feature-rich PTHxx030W, these products were designed to be very flexible, yet simple to use. The features vary with each product. Table 3-1 provides a quick reference to the available features by product and input bus voltage.

Table 3-1; Operating Features by Series and Input Bus Voltage

		Adjust (Trim)	On/Off Inhibit	Over-Current	Pre-Bias Startup	Auto-Track™	Margin Up/Down	Output Sense	Thermal Shutdown	
Series	Input Bus	I <sub>OUT</sub>	Adju	)/uO	Ove	Pre-	Autc	Mar	Out	The
PTHxx050	3.3 V / 5 V	6 A	•	•	•	•	•			
1 1110000	12 V	6 A	•	•	•		•			
PTHxx060	3.3 V / 5 V	10 A	•	•	•	•	•	•	•	
1 11122000	12 V	8 A	•	•	•		•	•	•	
PTHxx010	3.3 V / 5 V	15 A	•	•	•	•	•	•	•	
1 11122010	12 V	12 A	•	•	•		•	•	•	
PTHxx020	3.3 V / 5 V	22 A	•	•	•	٠	•	•	•	•
PINXXU2U	12 V	18 A	•	•	•		•	•	•	•
DTIL 000	3.3 V / 5 V	30 A	•	•	•	٠	•	•	•	•
PTHxx030	12 V	26 A	•	•	•	•	•	•	•	•

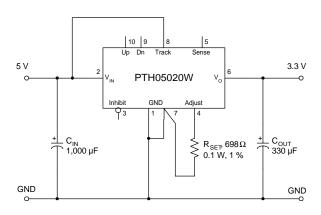
For simple point-of-use applications, the PTHxx050W provides operating features such as an on/off inhibit, output voltage trim, pre-bias startup (3.3/5-V input only), and over-current protection. The PTHxx060W (10 A), and PTHxx010W (15/12 A) include an output voltage sense, and margin up/down controls. Then the higher

output current, PTHxx020W and PTHxx030W products incorporate over-temperature shutdown protection. All of the products referenced in Table 3-1 include Auto-Track<sup>TM</sup>. This is a feature unique to the PTH family, and was specifically designed to simplify the task of sequencing the supply voltage in a power system. These and other features are described in the following sections.

#### **Soft-Start Power Up**

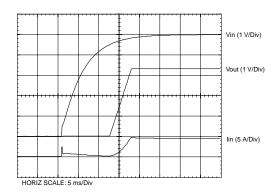
The Auto-Track feature allows the power-up of multiple PTH modules to be directly controlled from the Track pin. However in a stand-alone configuration, or when the Auto-Track feature is not being used, the Track pin should be directly connected to the input voltage,  $V_{in}$  (see Figure 3-1).

Figure 3-1



When the *Track* pin is connected to the input voltage the Auto-Track function is permanently disengaged. This allows the module to power up entirely under the control of its internal soft-start circuitry. When power up is under soft-start control, the output voltage rises to the set-point at a quicker and more linear rate.

Figure 3-2



From the moment a valid input voltage is applied, the soft-start control introduces a short time delay (typically 5 ms-10 ms) before allowing the output voltage to rise. The output then progressively rises to the module's setpoint voltage. Figure 3-2 shows the soft-start power-up characteristic of the 22-A output product (PTH05020W), operating from a 5-V input bus and configured for a 3.3-V output. The waveforms were measured with a 5-A resistive load, with Auto-Track disabled. The initial rise in input current when the input voltage first starts to rise is the charge current drawn by the input capacitors. Power-up is complete within 15 ms.

#### **Over-Current Protection**

For protection against load faults, all modules incorporate output over-current protection. Applying a load that exceeds the regulator's over-current threshold will cause the regulated output to shut down. Following shutdown a module will periodically attempt to recover by initiating a soft-start power-up. This is described as a "hiccup" mode of operation, whereby the module continues in a cycle of successive shutdown and power up until the load fault is removed. During this period, the average current flowing into the fault is significantly reduced. Once the fault is removed, the module automatically recovers and returns to normal operation.

#### **Over-Temperature Protection**

The PTHxx020 and PTHxx030 series of products have over-temperature protection. These products have an on-board temperature sensor that protects the module's internal circuitry against excessively high temperatures. A rise in the internal temperature may be the result of a drop in airflow, or a high ambient temperature. If the internal temperature exceeds the OTP threshold, the module's *Inbibit* control is automatically pulled low. This turns the output off. The output voltage will drop as the external output capacitors are discharged by the load circuit. The recovery is automatic, and begins with a soft-start power up. It occurs when the the sensed temperature decreases by about 10 °C below the trip point.

Note: The over-temperature protection is a last resort mechanism to prevent thermal stress to the regulator. Operation at or close to the thermal shutdown temperature is not recommended and will reduce the long-term reliability of the module. Always operate the regulator within the specified Safe Operating Area (SOA) limits for the worst-case conditions of ambient temperature and airflow.

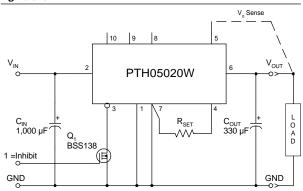
#### **Output On/Off Inhibit**

For applications requiring output voltage on/off control, each series of the PTH family incorporates an output *Inhibit* control pin. The inhibit feature can be used wherever there is a requirement for the output voltage from the regulator to be turned off.

The power modules function normally when the *Inhibit* pin is left open-circuit, providing a regulated output whenever a valid source voltage is connected to  $V_{in}$  with respect to GND.

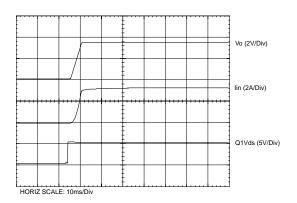
Figure 3-3 shows the typical application of the inhibit function. Note the discrete transistor  $(Q_1)$ . The *Inhibit* control has its own internal pull-up to  $V_{in}$  potential. The input is not compatible with TTL logic devices. An open-collector (or open-drain) discrete transistor is recommended for control.

Figure 3-3



Turning  $Q_1$  on applies a low voltage to the *Inhibit* control and disables the output of the module. If  $Q_1$  is then turned off, the module will execute a soft-start power-up. A regulated output voltage is produced within 20 msec. Figure 3-4 shows the typical rise in both the output voltage and input current, following the turn-off of  $Q_1$ . The turn off of  $Q_1$  corresponds to the rise in the waveform,  $Q_1 V_{ds}$ . The waveforms were measured with a 5-A load.

Figure 3-4



#### Auto-Track™ Function

The Auto-Track function is unique to the PTH family, and is available with the all "Point-of-Load Alliance" (POLA) products. Auto-Track was designed to simplify the amount of circuitry required to make the output voltage from each module power up and power down in sequence. The sequencing of two or more supply voltages during power up is a common requirement for complex mixed-signal applications, that use dual-voltage VLSI ICs such as DSPs, micro-processors, and ASICs.

#### How Auto-Track Works

Auto-Track works by forcing the module's output voltage to follow a voltage presented at the *Track* control pin. This control range is limited to between 0 V and the module's set-point voltage. Once the track-pin voltage is raised above the set-point voltage, the module's output remains at its set-point <sup>1</sup>. As an example, if the Track pin of a 2.5-V regulator is at 1 V, the regulated output will be 1 V. But if the voltage at the Track pin rises to 3 V, the regulated output will not go higher than 2.5 V.

When under track control, the regulated output from the module follows the voltage at its Track pin on a volt-for-volt basis. By connecting the Track pin of a number of these modules together, the output voltages will follow a common signal during power-up and power-down. The control signal can be an externally generated master ramp waveform, or the output voltage from another power supply circuit <sup>3</sup>. For convenience the Track control incorporates an internal RC charge circuit. This operates off the module's input voltage to provide a suitable rising voltage ramp waveform.

#### **Typical Application**

The basic implementation of Auto-Track allows for simultaneous voltage sequencing of a number of Auto-Track compliant modules. Connecting the Track control pins of two or more modules forces the Track control of all modules to follow the same collective RC ramp waveform, and allows them to be controlled through a single transistor or switch;  $Q_1$  in Figure 3-5.

To initiate a power-up sequence the Track control must first pulled to ground potential. This should be done at or before input power is applied to the modules, and then held for at least 10 ms thereafter. This brief period gives the modules time to complete their internal soft-start initialization, which enables them to produce an output voltage.

Applying a logic-level high signal to the circuit's On/Off Control turns  $Q_1$  on and applies a ground signal to the Track control. After completing their internal soft-start intialization, the output of all modules will remain at zero volts while  $Q_1$  is on. 10 ms after a valid input voltage has been applied to all modules,  $Q_1$  can be turned off. This allows the track control voltage to automatically rise toward to the modules' input voltage. During this period the output voltage of each module will rise in unison with

other modules, to its respective set-point voltage.

Figure 3-6 shows the output voltage waveforms from the circuit of Figure 3-5 after the On/Off Control is set from a high to a low-level voltage. The waveforms,  $V_{01}$  and  $V_{02}$  represent the output voltages from the two power modules,  $U_1$  (3.3 V) and  $U_2$  (1.8 V) respectively.  $V_{01}$  and  $V_{02}$  are shown rising together to produce the desired simultaneous power-up characteristic.

The same circuit also provides a power-down sequence. Power down is the reverse of power up, and is accomplished by lowering the track control voltage back to zero volts. The important constraint is that a valid input voltage must be maintained until the power down is complete. It also requires that  $Q_1$  be turned off relatively slowly. This is so that the Track control voltage does not fall faster than Auto-Track's slew rate capability, which is 1 V/ms. The components  $R_1$  and  $C_1$  in Figure 3-5 limit the rate at which  $Q_1$  can pull down the Track control voltage. The values of 100 k-ohm and 0.1  $\mu$ F correlate to a decay rate of about 0.17 V/ms.

The power-down sequence is initiated with a low-to-high transition at the On/Off Control input to the circuit. Figure 3-7 shows the power-down waveforms. As the Track control voltage falls below the nominal set-point voltage of each power module, then its output voltage decays with all the other modules under Auto-Track control.

#### Notes on Use of Auto-Track<sup>TM</sup>

- 1. The Track pin voltage must be allowed to rise above the module's set-point voltage before the module can regulate at its adjusted set-point voltage.
- 2. The Auto-Track function will track almost any voltage ramp during power up, and is compatible with ramp speeds of up to 1 V/ms.
- 3. The absolute maximum voltage that may be applied to the Track pin is  $V_{\rm in}$ .
- 4. The module will not follow a voltage at its Track control input until it has completed its soft-start initialization. This takes about 10 ms from the time that the module has sensed that a valid voltage has been applied its input. During this period, it is recommended that the Track pin be held at ground potential.
- 5. The module is capable of both sinking and sourcing current when following a voltage at its Track pin. Therefore startup into an output prebias is not supported during Auto-Track control. <u>Note</u>: A pre-bias holdoff is not necessary when all supply voltages rise simultaneously under the control of Auto-Track.
- 6. The Auto-Track function can be disabled by connecting the *Track* pin to the input voltage (*V<sub>in</sub>*). With Auto-Track disabled, the output voltage will rise at a quicker and more linear rate after input power is applied.



Figure 3-5; Sequenced Power Up & Power Down Using Auto-Track

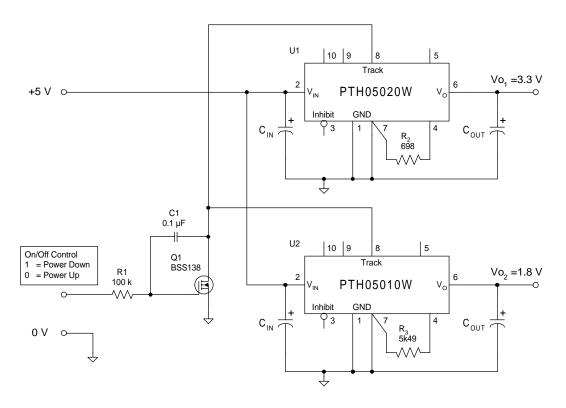
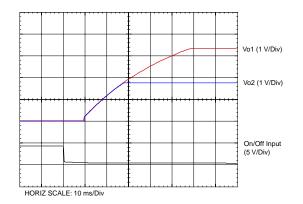
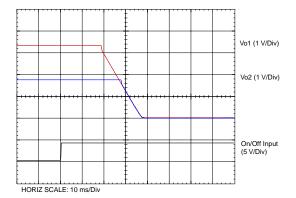


Figure 3-6; Simultaneous Power Up with Auto-Track Control

Figure 3-7; Simultaneous Power Down with Auto-Track Control





#### Margin Up/Down Controls

The PTHxx060W, PTHxx010W, PTHxx020W, and PTHxx030W products incorporate *Margin Up* and *Margin Down* control inputs. These controls allow the output voltage to be momentarily adjusted <sup>1</sup>, either up or down, by a nominal 5 %. This provides a convenient method for dynamically testing the operation of the load circuit over its supply margin or range. It can also be used to verify the function of supply voltage supervisors. The  $\pm 5$  % change is applied to the adjusted output voltage, as set by the external resistor,  $R_{\text{set}}$  at the  $V_0$  *Adjust* pin.

The 5 % adjustment is made by pulling the appropriate margin control input directly to the *GND* terminal <sup>2</sup>. A low-leakage open-drain device, such as an n-channel MOSFET or p-channel JFET is recommended for this purpose <sup>3</sup>. Adjustments of less than 5 % can also be accommodated by adding series resistors to the control inputs. The value of the resistor can be selected from Table 3-2, or calculated using the following formula.

#### Up/Down Adjust Resistance Calculation

To reduce the margin adjustment to something less than 5 %, series resistors are required (See  $R_D$  and  $R_U$  in Figure 3-8). For the same amount of adjustment, the resistor value calculated for  $R_U$  and  $R_D$  will be the same. The formulas is as follows.

$$R_{\rm U}$$
 or  $R_{\rm D}$ =  $\frac{499}{\Delta\%}$  - 99.8  $k\Omega$ 

Where  $\Delta\%$  = The desired amount of margin adjust in percent.

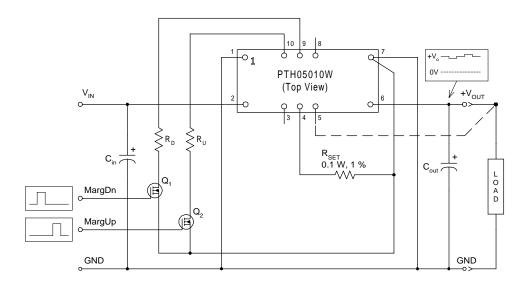
#### Notes:

- 1. The *Margin Up\** and *Margin Dn\** controls were not intended to be activated simultaneously. If they are their affects on the output voltage may not completely cancel, resulting in the possibility of a slightly higher error in the output voltage set point.
- 2. The ground reference should be a direct connection to the module GND at pin 7 (pin 1 for the PTHxx050). This will produce a more accurate adjustment at the load circuit terminals. The transistors Q<sub>1</sub> and Q<sub>2</sub> should be located close to the regulator.
- 3. The Margin Up and Margin Dn control inputs are not compatible with devices that source voltage. This includes TTL logic. These are analog inputs and should only be controlled with a true open-drain device (preferably a discrete MOSFET transistor). The device selected should have low off-state leakage current. Each input sources 8 μA when grounded, and has an open-circuit voltage of 0.8 V.

Table 3-2; Margin Up/Down Resistor Values

% Adjust	R <sub>U</sub> / R <sub>D</sub>	
5	$0.0 \text{ k}\Omega$	
4	24.9 kΩ	
3	66.5 kΩ	
2	$150.0\mathrm{k}\Omega$	
1	$397.0 \mathrm{k}\Omega$	

Figure 3-8; Margin Up/Down Application Schematic



#### **Pre-Bias Startup Capability**

Only selected products in the PTH family incorporate this capability. Consult Table 3-1 to identify which products are compliant.

A pre-bias startup condition occurs as a result of an external voltage being present at the output of a power module prior to its output becoming active. This often occurs in complex digital systems when current from another power source is backfed through a dual-supply logic component, such as an FPGA or ASIC. Another path might be via clamp diodes as part of a dual-supply power-up sequencing arrangement. A prebias can cause problems with power modules that incorporate synchronous rectifiers. This is because under most operating conditions, these types of modules can sink as well as source output current.

The PTH family of power modules incorporate synchronous rectifiers, but will not sink current during startup  $^1$ , or whenever the *Inhibit* pin is held low. However, to ensure satisfactory operation of this function, certain conditions must be maintained.  $^2$  Figure  $^3$ -9 shows an application demonstrating the pre-bias startup capability. The startup waveforms are shown in Figure  $^3$ -10. Note that the output current from the PTH03010W ( $^1$ 0) shows negligible current until its output voltage rises above that backfed through diodes  $^1$  and  $^1$ 2.

Note: The pre-bias start-up feature is not compatible with Auto-Track. When the module is under Auto-Track control, it will sink current if the output voltage is below that of a back-feeding source. To ensure a pre-bias hold-off one of two approaches must be followed when input power is applied to the module. The Auto-Track function must either be disabled 3, or the module's output held off (for at least 50 ms) using the Inhibit pin. Either approach ensures that the Track pin voltage is above the set-point voltage at start up.

#### Notes

- 1. Startup includes the short delay (approx. 10 ms) prior to the output voltage rising, followed by the rise of the output voltage under the module's internal soft-start control. Startup is complete when the output voltage has risen to either the set-point voltage or the voltage at the *Track* pin, whichever is lowest.
- 2. To ensure that the regulator does not sink current when power is first applied (even with a ground signal applied to the *Inhibit* control pin), the input voltage <u>must</u> always be greater than the output voltage <u>throughout</u> the power-up and power-down sequence.
- 3. The Auto-Track function can be disabled at power up by immediately applying a voltage to the module's Track pin that is greater than its set-point voltage. This can be easily accomplished by connecting the Track pin to  $V_{in}$ .

Figure 3-10; Pre-Bias Startup Waveforms

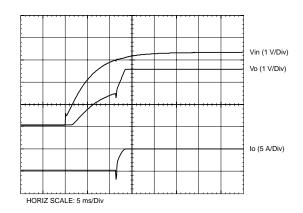
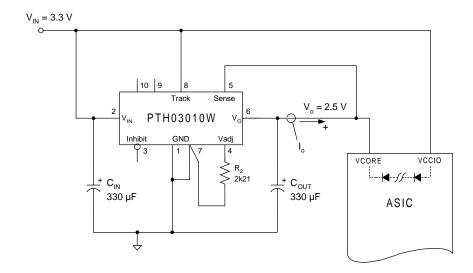


Figure 3-9; Application Circuit Demonstrating Pre-Bias Startup



#### **Application Notes**

PTH Series of Wide-Output Adjust Power Modules (3.3/5-V Input)

#### **Remote Sense**

The PTHxx060W, PTHxx010W, PTHxx020W, and PTHxx030W products incorporate an output voltage sense pin,  $V_0$  Sense. The  $V_0$  Sense pin should be connected to  $V_{out}$  at the load circuit (see data sheet standard application). A remote sense improves the load regulation performance of the module by allowing it to compensate for any 'IR' voltage drop between itself and the load. An IR drop is caused by the high output current flowing through the small amount of pin and trace resistance. Use of the remote sense is optional. If not used, the  $V_0$  Sense pin can be left open-circuit. An internal low-value resistor (15- $\Omega$  or less) is connected between the  $V_0$  Sense and  $V_{out}$ . This ensures the output voltage remains in regulation.

With the sense pin connected, the difference between the voltage measured directly between the  $V_{out}$  and GND pins, and that measured from  $V_o$  Sense to GND, is the amount of IR drop being compensated by the regulator. This should be limited to a maximum of 0.3 V.

Note: The remote sense feature is not designed to compensate for the forward drop of non-linear or frequency dependent components that may be placed in series with the converter output. Examples include OR-ing diodes, filter inductors, ferrite beads, and fuses. When these components are enclosed by the remote sense connection they are effectively placed inside the regulation control loop, which can adversely affect the stability of the regulator.







27-Apr-2017

#### PACKAGING INFORMATION

Orderable Device	Ctotus	Bookogo Tura	Dookogo	Dinc	Dookogo	Eco Plan	Lead/Ball Finish	MCI Dook Town	On Town (°C)	Device Marking	Comples
Orderable Device	Status	Package Type	Drawing	Pins	Package Qty	(2)	(6)	MSL Peak Temp	Op Temp (°C)	(4/5)	Samples
PTH05030WAD	ACTIVE	Through- Hole Module	EUM	13	16	RoHS (In Work) & Green (In Work)	SN	N / A for Pkg Type	-40 to 85	(40)	Samples
PTH05030WAH	ACTIVE	Through- Hole Module	EUM	13	16	RoHS (In Work) & Green (In Work)	SN	N / A for Pkg Type	-40 to 85		Samples
PTH05030WAS	ACTIVE	Surface Mount Module	EUN	13	16	RoHS (In Work) & Green (In Work)	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH05030WAST	ACTIVE	Surface Mount Module	EUN	13	200	RoHS (In Work) & Green (In Work)	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH05030WAZ	ACTIVE	Surface Mount Module	EUN	13	16	RoHS (In Work) & Green (In Work)	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples
PTH05030WAZT	ACTIVE	Surface Mount Module	EUN	13	200	RoHS (In Work) & Green (In Work)	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



### **PACKAGE OPTION ADDENDUM**

27-Apr-2017

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

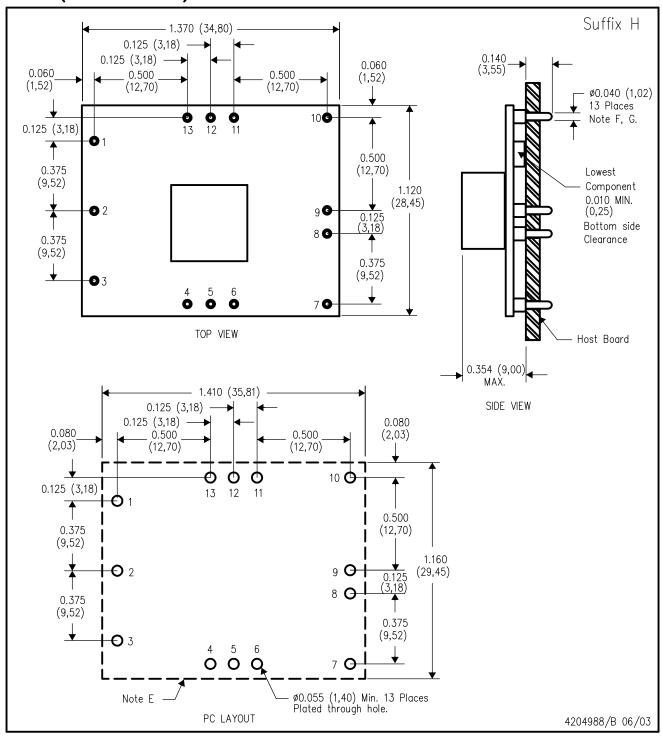
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## EUM (R-PDSS-T13)

## DOUBLE SIDED MODULE



NOTES:

- All linear dimensions are in inches (mm).
- This drawing is subject to change without notice.
- 2 place decimals are  $\pm 0.030$  ( $\pm 0.76$ mm). 3 place decimals are  $\pm 0.010$  ( $\pm 0.25$ mm).
- Recommended keep out area for user components.
- F. Pins are 0.040" (1,02) diameter with 0.070" (1,78) diameter standoff shoulder.
- G. All pins: Material Copper Alloy Finish Tin (100%) over Nickel plate



#### DOUBLE SIDED MODULE EUN (R-PDSS-B13) Suffix S 1.370 (34,80) 0.125 (3,18) 0.377 (9,57) 0.125 (3.18) MAX. 0.060 0.060 0.500 0.500 See Note J (1,52)(12,70)(12,70)(1,52)100 Solder Ball 0.125 (3,18) 13 12 Ø0.040 (1,02) 13 Places 0.500 (12,70)0.375 Note I (9,52)1.120 (28,45)90 **②** 2 0.125 (3,18) 8 😉 0.375 (9,52)0.375 (9,52)**•**3 0 7 🚱 TOP VIEW SIDE VIEW 1.410 (35,81) 0.125 (3,18) 0.125 (3,18) 0.080 0.080 0.500 0.500 (2,03)(12,70)(2,03)(12,70)10 0.125 (3,18) 12 Lowest 0.500 Component (12,70)0.375 0.010 MIN. (9,52)(0,25)1.160 Bottom side 0.125 (29,45) Clearance (3,18)0.375 (9,52)0.375 (9,52)Host Board Note E Ø0.085 (2,16) 13 Places See Note F, G & H

NOTES: All linear dimensions are in inches (mm).

- This drawing is subject to change without notice.
- 2 place decimals are  $\pm 0.030$  ( $\pm 0.76$ mm).
- 3 place decimals are  $\pm 0.010$  ( $\pm 0.25$ mm).
- Recommended keep out area for user components.
- Power pin connection should utilize two or more vias to the interior power plane of 0.025 (0,63) I.D. per input, ground and output pin (or the electrical equivalent).

PC LAYOUT

Paste screen opening: 0.080 (2,03) to 0.085 (2,16). Paste screen thickness: 0.006 (0,15).

0.354 (9,00)

MAX.

- H. Pad type: Solder mask defined.
- I. All pins: Material Copper Alloy

Finish — Tin (100%) over Nickel plate Solder Ball — See product data sheet.

4204989/B 06/03

J. Dimension prior to reflow solder.



#### **IMPORTANT NOTICE**

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (http://www.ti.com/sc/docs/stdterms.htm) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services.

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

TI's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's non-compliance with the terms and provisions of this Notice.